

# BIPOLAR ANALOG INTEGRATED CIRCUIT

# $\mu$ PC1678G

### 5 V-BIAS, +17.5 dBm OUTPUT, 2.0 GHz WIDEBAND Si MMIC AMPLIFIER

#### DESCRIPTION

The  $\mu$ PC1678G is a silicon monolithic integrated circuit designed as medium output power amplifier for high frequency system applications. Due to +17.5 dBm TYP. output at 2 GHz, this IC is recommendable for transmitter stage amplifier of L BAND wireless communication systems. This IC is packaged in 8-pin plastic SOP.

This IC is manufactured using NEC's 20 GHz fr NESAT™IV silicon bipolar process. This process uses silicon nitride passivation film and gold electrodes. These materials can protect chip surface from external pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

#### FEATURES

- Supply voltage :  $V_{CC} = 4.5$  to  $5.5$  V
- Saturated output power :  $P_{O(sat)} = +17.5$  dBm TYP. @  $f = 500$  MHz with external inductor
- Wideband response :  $f_u = 2.0$  GHz TYP. @ 3 dB bandwidth
- Power gain :  $G_P = 23$  dB TYP. @  $f = 500$  MHz
- Isolation :  $ISL = 35$  dB TYP. @  $f = 500$  MHz

#### APPLICATIONS

- PA driver for high frequency system.

#### ORDERING INFORMATION

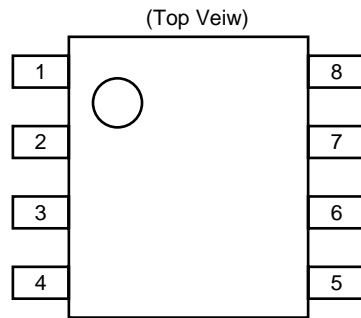
| Part Number       | Package                     | Marking | Supplying Form   |
|-------------------|-----------------------------|---------|--|
| $\mu$ PC1678G     | 8-pin plastic SOP (225 mil) | 1678    | Plastic magazine case  |
| $\mu$ PC1678G -E1 |                             |         | Embossed tape 12 mm wide.<br>1 pin is tape pull-out direction.<br>Qty 2.5 kp/reel. |
| $\mu$ PC1678G -E2 |                             |         | Embossed tape 12 mm wide.<br>1 pin is tape roll-in direction.<br>Qty 2.5 kp/reel.  |

**Remark** To order evaluation samples, please contact your local NEC sales office.  
(Part number for sample order:  $\mu$ PC1678G)

**Caution Electro-static sensitive devices**

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.  
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

PIN CONNECTIONS



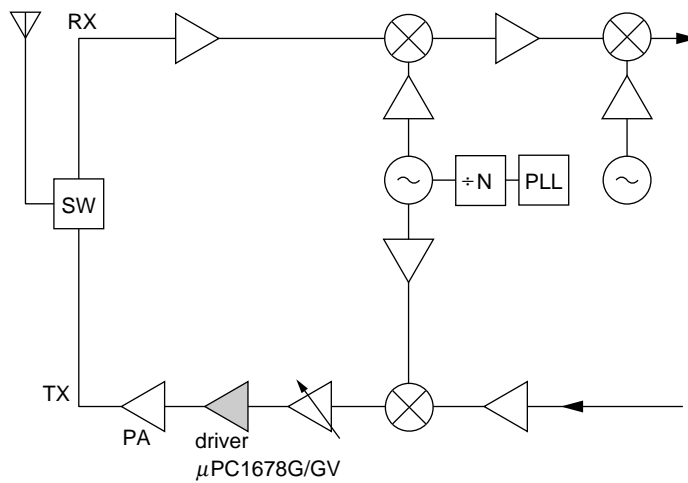
| Pin No. | Pin Name        |
|---------|-----------------|
| 1       | INPUT           |
| 2       | GND             |
| 3       | GND             |
| 4       | GND             |
| 5       | OUTPUT          |
| 6       | GND             |
| 7       | GND             |
| 8       | V <sub>CC</sub> |

PRODUCT LINE-UP (T<sub>A</sub> = +25 °C, V<sub>CC</sub> = V<sub>out</sub> = 5.0 V, Z<sub>L</sub> = Z<sub>S</sub> = 50 Ω)

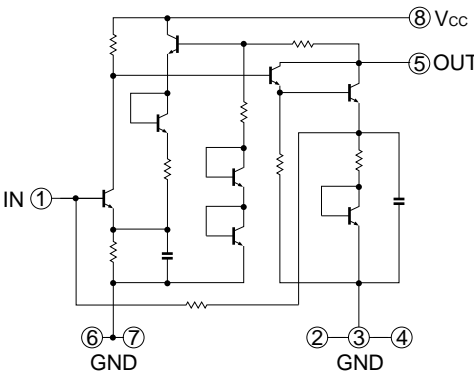
| Part Number | f <sub>u</sub> (GHz) | P <sub>O(sat)</sub> (dBm) | G <sub>p</sub> (dB) | NF (dB) | I <sub>CC</sub> (mA) | Package                      |
|-------------|----------------------|---------------------------|---------------------|---------|----------------------|------------------------------|
| μPC1678G    | 2.0                  | +17.5                     | 23                  | 6.0     | 49                   | 8-pin plastic SOP (225 mil)  |
| μPC1678GV   | 2.0                  | +17.5                     | 23                  | 6.0     | 49                   | 8-pin plastic SSOP (175 mil) |

**Remark** Typical performance. Please refer to **ELECTRICAL CHARACTERISTICS** in detail.

SYSTEM APPLICATION EXAMPLE



**PIN EXPLANATION**

| Pin No.               | Pin Name | Applied Voltage (V)                                   | Function and Applications   | Internal Equivalent Circuit   |
|-----------------------|----------|---|---|---|
| 1                     | INPUT    | –   | Signal input pin. A internal matching circuit, configured with resistors, enables 50 Ω connection over a wide band. A multi-negative feedback circuit is designed to cancel the deviations of $h_{FE}$ and resistance. This pin must be coupled to signal source with capacitor for DC cut. |  <p>2, 3, 4, 6 and 7 are shorted by a lead frame.</p> |
| 2<br>3<br>4<br>6<br>7 | GND      | 0   | Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as widely as possible. All the ground pins must be connected together with wide ground pattern to decrease impedance difference.                            |   |
| 5                     | OUTPUT   | Voltage as same as $V_{CC}$ through external inductor | Signal output pin. The inductor must be attached between $V_{CC}$ and output pins to supply current to the internal output transistors.   |   |
| 8                     | $V_{CC}$ | 4.5 to 5.5  | Power supply pin, which biases the internal input transistors. This pin should be externally equipped with bypass capacitor to minimize its impedance.  |   |

**ABSOLUTE MAXIMUM RATINGS**

| Parameter                     | Symbol           | Conditions   | Rating      | Unit |
|-------------------------------|------------------|--|-------------|------|
| Supply Voltage                | V <sub>CC</sub>  | T <sub>A</sub> = +25 °C, pin 5 and 8   | 6           | V    |
| ★ Power Dissipation           | P <sub>D</sub>   | Mounted on double copper clad 50 × 50 × 1.6 mm epoxy glass PWB (T <sub>A</sub> = +85 °C) | 360         | mW   |
| Operating Ambient Temperature | T <sub>A</sub>   |  | -45 to +85  | °C   |
| Storage Temperature           | T <sub>stg</sub> |  | -55 to +150 | °C   |
| Input Power                   | P <sub>in</sub>  | T <sub>A</sub> = +25 °C  | +10         | dBm  |

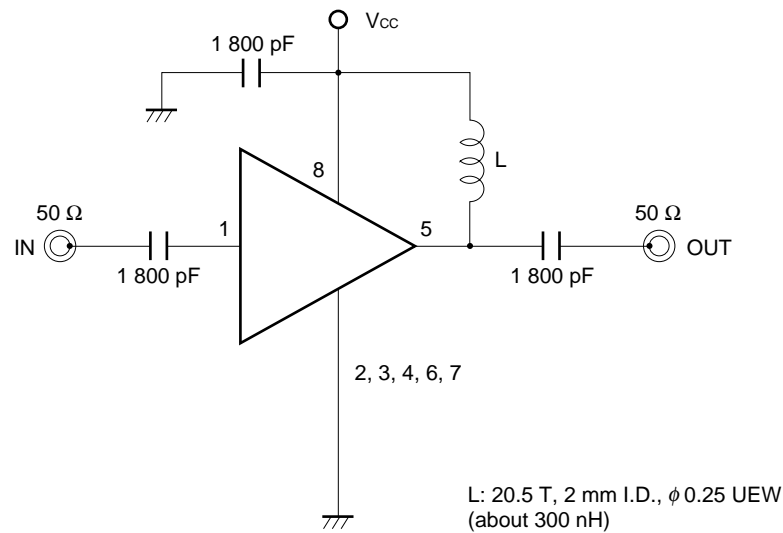
**RECOMMENDED OPERATING RANGE**

| Parameter                     | Symbol          | MIN. | TYP. | MAX. | Unit | Notice  |
|-------------------------------|-----------------|------|------|------|------|---|
| Supply Voltage                | V <sub>CC</sub> | 4.5  | 5.0  | 5.5  | V    | The same voltage should be applied to pin 5 and 8 |
| Operating Ambient Temperature | T <sub>A</sub>  | -45  | +25  | +85  | °C   |   |

**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = +25 °C, V<sub>CC</sub> = V<sub>out</sub> = 5.0 V, Z<sub>S</sub> = Z<sub>L</sub> = 50 Ω)**

| Parameter                       | Symbol              | Conditions                          | MIN.  | TYP.  | MAX. | Unit |
|---------------------------------|---------------------|-------------------------------------|-------|-------|------|------|
| Circuit Current                 | I <sub>CC</sub>     | No signal                           | 40.0  | 49.0  | 60.0 | mA   |
| Power Gain                      | G <sub>P</sub>      | f = 500 MHz                         | 21    | 23    | 25   | dB   |
| Noise Figure                    | NF                  | f = 500 MHz                         | -     | 6.0   | 8.0  | dB   |
| Upper Limit Operating Frequency | f <sub>u</sub>      | 3 dB down below the gain at 0.1 GHz | 1.7   | 2.0   | -    | GHz  |
| Isolation                       | ISL                 | f = 500 MHz                         | 30    | 35    | -    | dB   |
| Input Return Loss               | RL <sub>in</sub>    | f = 500 MHz                         | 11    | 14    | -    | dB   |
| Output Return Loss              | RL <sub>out</sub>   | f = 500 MHz                         | 1     | 4     | -    | dB   |
| Saturated Output Power          | P <sub>O(sat)</sub> | f = 500 MHz                         | +15.5 | +17.5 | -    | dBm  |

## TEST CIRCUIT

**INDUCTOR FOR THE OUTPUT PIN**

The internal output transistor of this IC consumes 30 mA, to output medium power. To supply current for output transistor, connect an inductor between the Vcc pin (pin 8) and output pin (pin 5).

The inductor has both DC and AC effects. In terms of DC, the inductor biases the output transistor with minimum voltage drop to output enable high level. In terms of AC, the inductor make output-port impedance higher to get enough gain. In this case, large inductance and Q is suitable.

**CAPACITORS FOR THE Vcc, INPUT AND OUTPUT PINS**

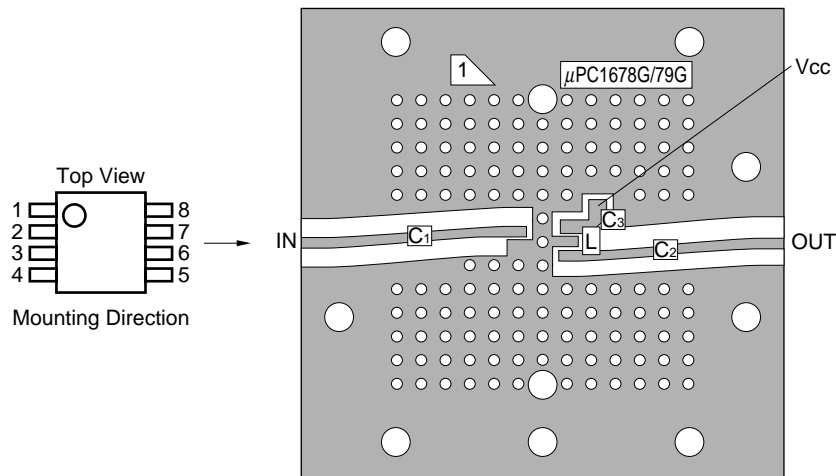
Capacitors of 1 800 pF are recommendable as the bypass capacitor for the Vcc pin and the coupling capacitors for the input and output pins.

The bypass capacitor connected to the Vcc pin is used to minimize ground impedance of Vcc pin. So, stable bias can be supplied against Vcc fluctuation.

The coupling capacitors, connected to the input and output pins, are used to cut the DC and minimize RF serial impedance. Their capacitance are therefore selected as lower impedance against a 50 Ω load. The capacitors thus perform as high pass filters, suppressing low frequencies to DC.

To obtain a flat gain from 100 MHz upwards, 1 800 pF capacitors are used in the test circuit. In the case of under 100 MHz operation, increase the value of coupling capacitor such as 10 000 pF. Because the coupling capacitors are determined by equation,  $C = 1/(2 \pi R f c)$ .

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



COMPONENT LIST

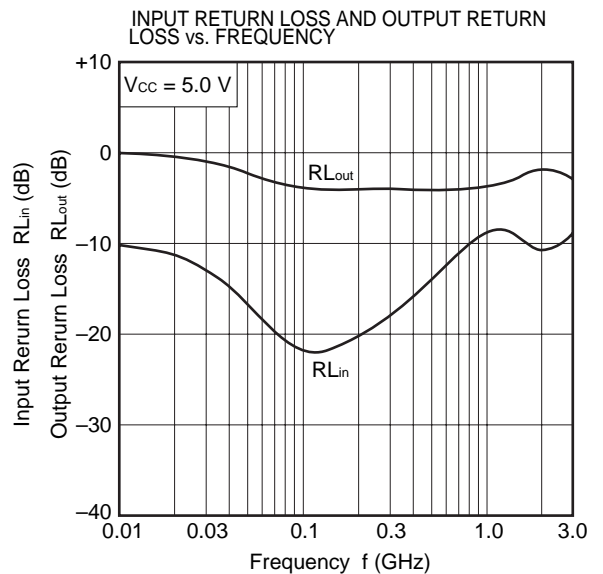
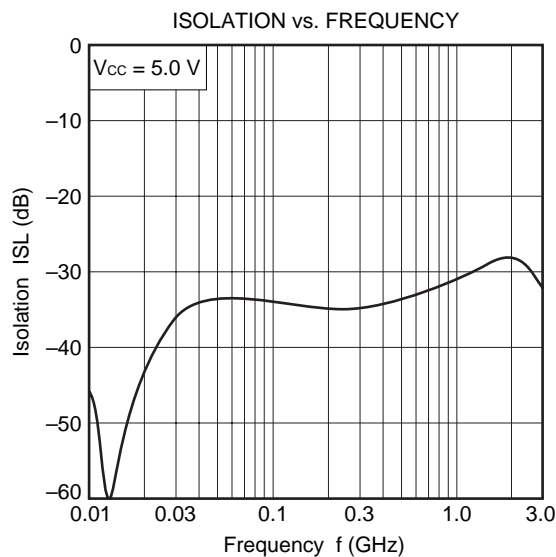
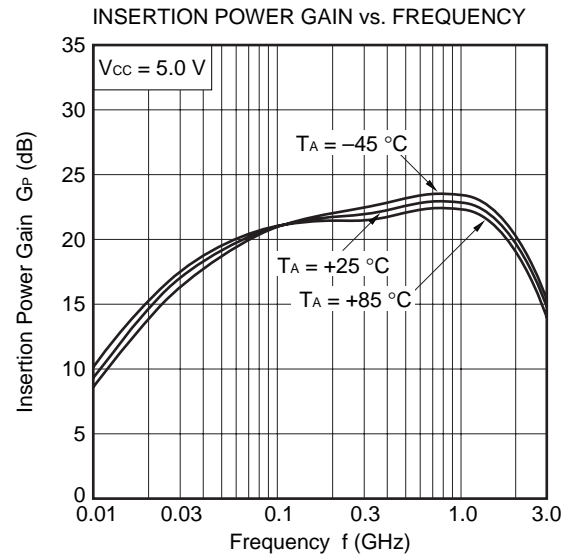
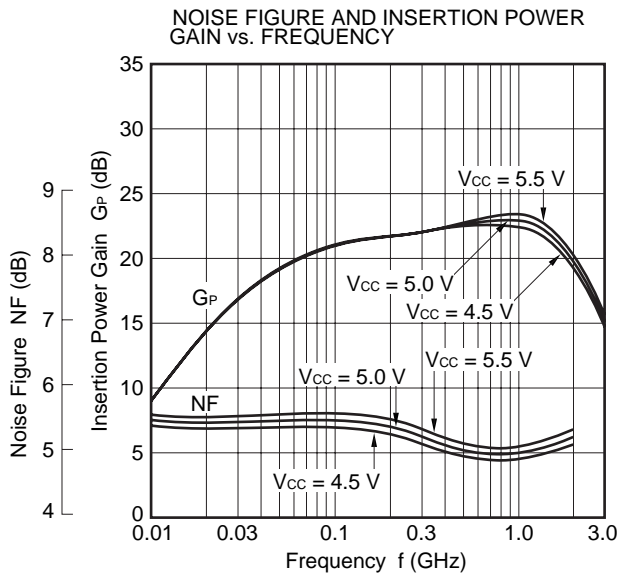
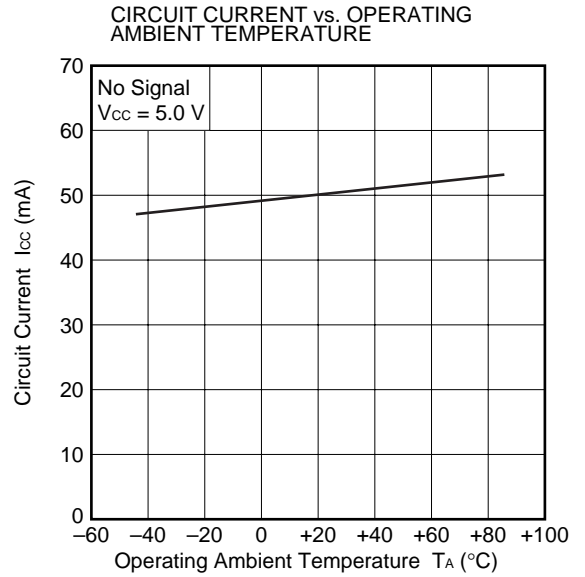
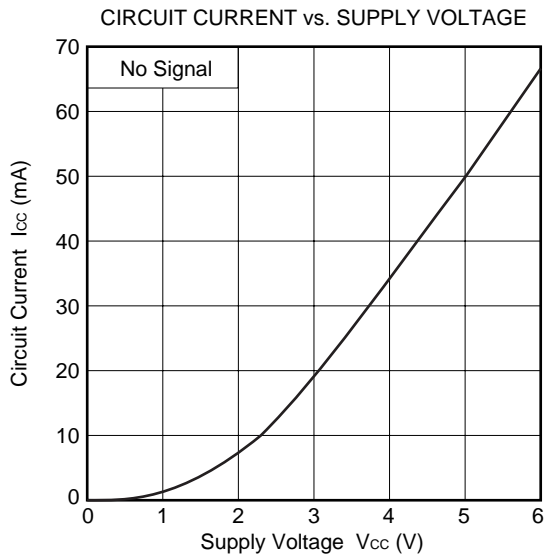
|                                  | Value    |
|----------------------------------|----------|
| C <sub>1</sub> to C <sub>3</sub> | 1 800 pF |
| L                                | 300 nH   |

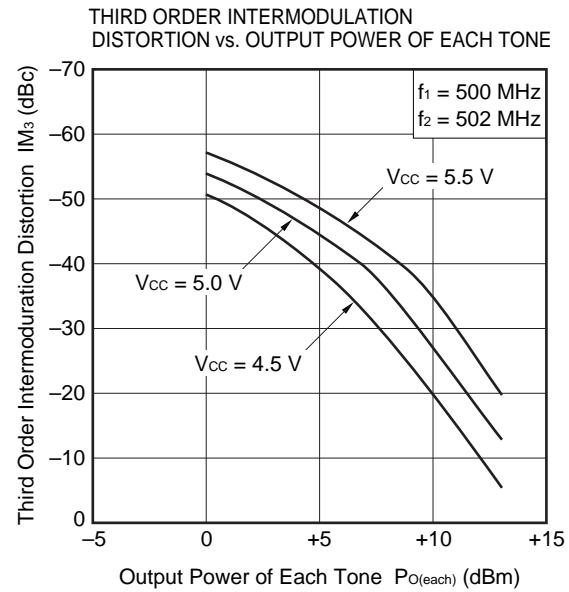
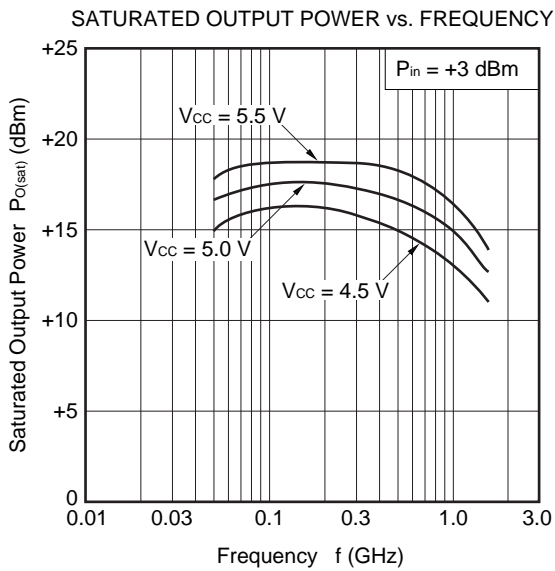
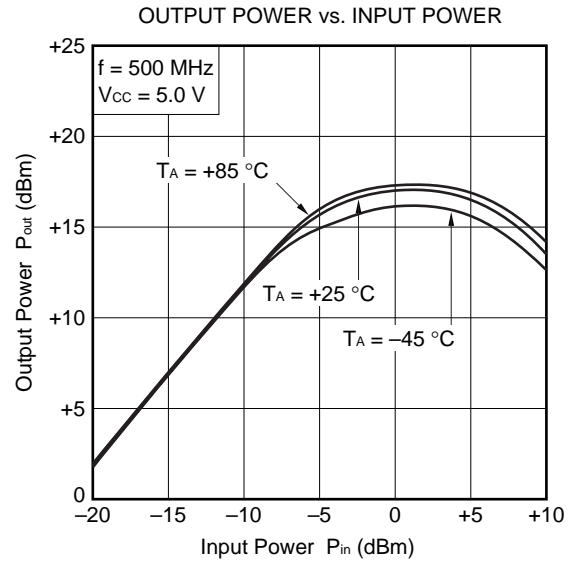
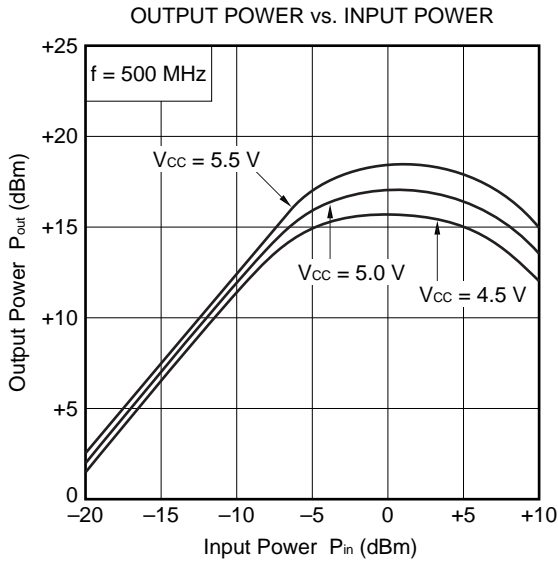
Notes

1. 50 × 50 × 0.4 mm double sided copper clad polyimide board.
2. Back side: GND pattern
3. Solder plated on pattern
4. ○ ○ : Through holes

For more information on the use of this IC, refer to the following application note: USAGE AND APPLICATION OF SILICON MEDIUM-POWER HIGH-FREQUENCY AMPLIFIER MMIC (P12152E).

**TYPICAL CHARACTERISTICS (Unless otherwise specified,  $T_A = +25\text{ }^\circ\text{C}$ )**

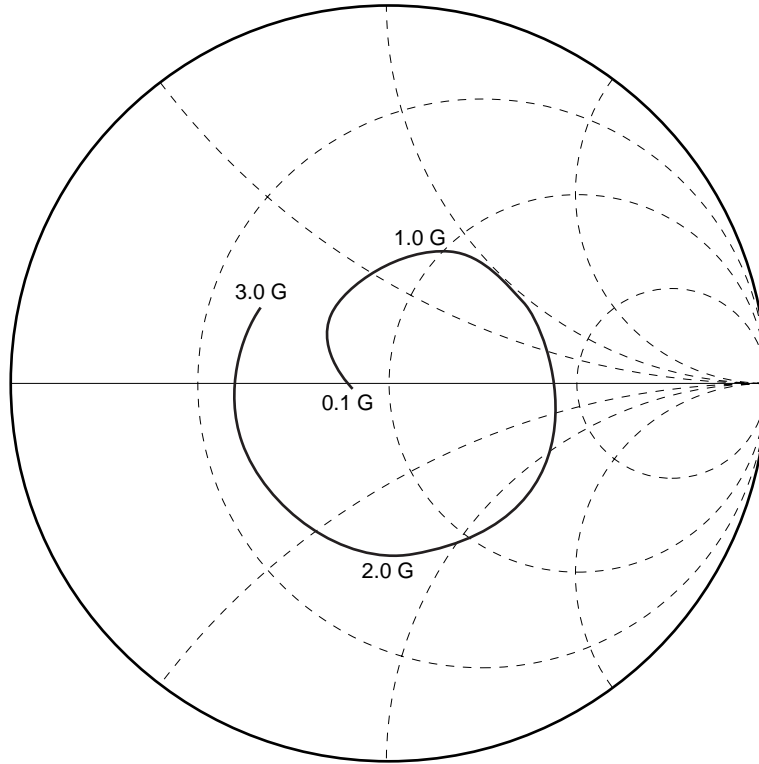




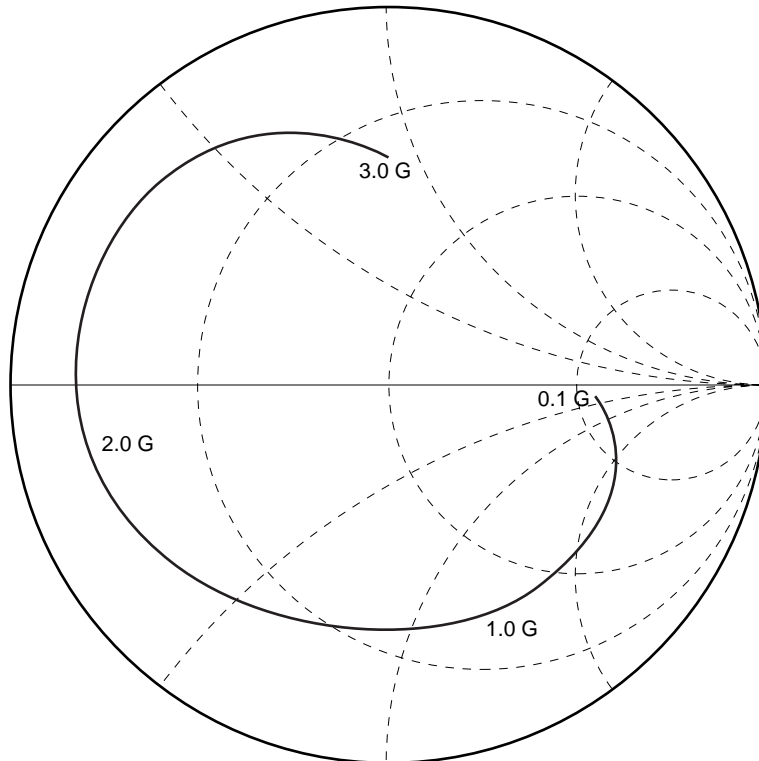


S-PARAMETER ( $T_A = +25\text{ }^\circ\text{C}$ ,  $V_{CC} = V_{out} = 5.0\text{ V}$ )

S<sub>11</sub>-FREQUENCY



S<sub>22</sub>-FREQUENCY



TYPICAL S-PARAMETER VALUES (T<sub>A</sub> = +25 °C)

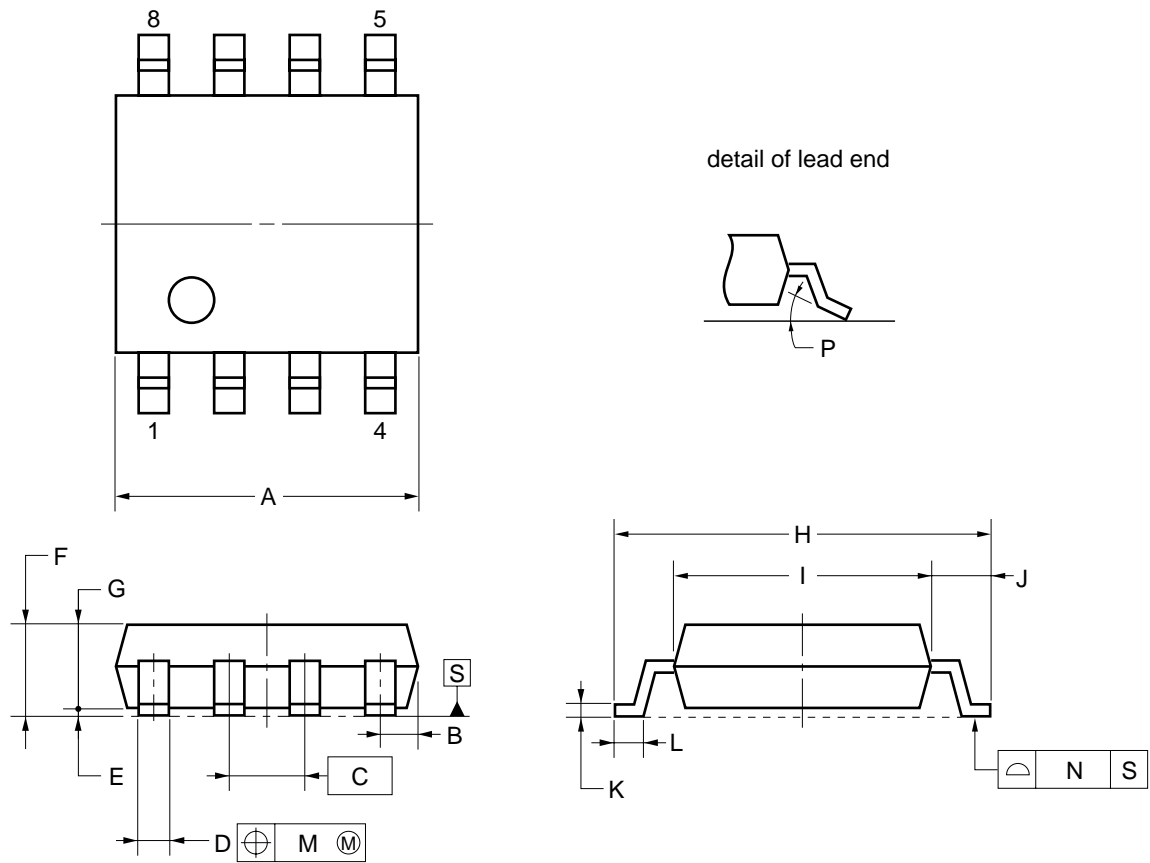
μPC1678G

V<sub>CC</sub> = V<sub>out</sub> = 5.0 V, I<sub>CC</sub> = 49 mA

| FREQUENCY<br>MHz | S <sub>11</sub> |        | S <sub>21</sub> |        | S <sub>12</sub> |       | S <sub>22</sub> |        | K    |
|------------------|-----------------|--------|-----------------|--------|-----------------|-------|-----------------|--------|------|
|                  | MAG.            | ANG.   | MAG.            | ANG.   | MAG.            | ANG.  | MAG.            | ANG.   |      |
| 100.0000         | 0.078           | -173.8 | 12.298          | -4.0   | 0.023           | -6.4  | 0.555           | -3.2   | 1.40 |
| 200.0000         | 0.106           | -179.1 | 12.891          | -8.6   | 0.020           | -7.3  | 0.593           | -8.7   | 1.43 |
| 300.0000         | 0.140           | 166.3  | 13.625          | -14.8  | 0.016           | -4.7  | 0.630           | -16.4  | 1.59 |
| 400.0000         | 0.176           | 150.2  | 14.453          | -22.6  | 0.014           | 6.4   | 0.657           | -25.3  | 1.53 |
| 500.0000         | 0.212           | 132.9  | 15.257          | -31.5  | 0.014           | 23.1  | 0.673           | -35.4  | 1.38 |
| 600.0000         | 0.246           | 115.5  | 15.663          | -40.8  | 0.017           | 35.1  | 0.676           | -45.1  | 1.05 |
| 700.0000         | 0.275           | 99.2   | 16.156          | -51.3  | 0.020           | 41.0  | 0.669           | -55.0  | 0.86 |
| 800.0000         | 0.304           | 83.2   | 16.291          | -60.7  | 0.024           | 42.4  | 0.654           | -64.0  | 0.71 |
| 900.0000         | 0.323           | 68.2   | 16.289          | -71.0  | 0.027           | 41.8  | 0.627           | -72.4  | 0.65 |
| 1000.0000        | 0.403           | 53.3   | 17.096          | -80.2  | 0.030           | 47.1  | 0.660           | -76.7  | 0.45 |
| 1100.0000        | 0.408           | 37.1   | 16.669          | -90.7  | 0.036           | 43.0  | 0.646           | -85.4  | 0.44 |
| 1200.0000        | 0.421           | 22.2   | 16.591          | -100.7 | 0.036           | 41.3  | 0.639           | -93.7  | 0.44 |
| 1300.0000        | 0.436           | 6.4    | 16.370          | -111.2 | 0.041           | 36.5  | 0.660           | -101.7 | 0.41 |
| 1400.0000        | 0.449           | -8.4   | 16.056          | -121.8 | 0.042           | 33.9  | 0.670           | -109.8 | 0.40 |
| 1500.0000        | 0.463           | -25.0  | 15.852          | -131.6 | 0.045           | 28.3  | 0.690           | -118.7 | 0.40 |
| 1600.0000        | 0.474           | -41.5  | 15.332          | -142.8 | 0.049           | 25.9  | 0.717           | -127.0 | 0.41 |
| 1700.0000        | 0.472           | -58.3  | 14.865          | -154.2 | 0.048           | 22.1  | 0.734           | -136.6 | 0.45 |
| 1800.0000        | 0.468           | -76.1  | 14.169          | -164.9 | 0.049           | 15.7  | 0.763           | -146.9 | 0.48 |
| 1900.0000        | 0.457           | -92.5  | 13.229          | -176.8 | 0.048           | 13.7  | 0.783           | -156.8 | 0.54 |
| 2000.0000        | 0.447           | -109.6 | 12.144          | 172.6  | 0.048           | 8.1   | 0.806           | -167.8 | 0.58 |
| 2100.0000        | 0.447           | -126.4 | 10.947          | 162.7  | 0.049           | 4.0   | 0.830           | -178.6 | 0.64 |
| 2200.0000        | 0.434           | -142.6 | 9.853           | 153.4  | 0.047           | -2.0  | 0.843           | 170.2  | 0.69 |
| 2300.0000        | 0.429           | -158.5 | 8.796           | 146.3  | 0.044           | -6.7  | 0.842           | 159.4  | 0.77 |
| 2400.0000        | 0.427           | -173.0 | 7.894           | 139.7  | 0.040           | -9.9  | 0.843           | 148.2  | 0.86 |
| 2500.0000        | 0.422           | 172.5  | 7.048           | 133.3  | 0.036           | -12.5 | 0.825           | 137.4  | 0.99 |
| 2600.0000        | 0.419           | 158.3  | 6.363           | 128.8  | 0.027           | -17.6 | 0.785           | 125.7  | 1.34 |
| 2700.0000        | 0.416           | 145.6  | 5.881           | 125.1  | 0.023           | -17.2 | 0.744           | 117.2  | 1.71 |
| 2800.0000        | 0.400           | 136.1  | 5.387           | 121.3  | 0.018           | 4.5   | 0.701           | 109.7  | 2.34 |
| 2900.0000        | 0.402           | 126.2  | 5.223           | 116.2  | 0.018           | 11.0  | 0.681           | 103.0  | 2.53 |
| 3000.0000        | 0.406           | 118.1  | 5.030           | 113.5  | 0.020           | 28.2  | 0.645           | 96.5   | 2.45 |
| 3100.0000        | 0.397           | 109.8  | 4.675           | 107.3  | 0.022           | 35.3  | 0.616           | 90.7   | 2.47 |

★ PACKAGE DIMENSIONS

8 PIN PLASTIC SOP (225 mil) (Unit: mm)



**NOTE**

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

| ITEM | MILLIMETERS                            |
|------|--|
| A    | 5.2±0.2                                |
| B    | 0.85 MAX.                              |
| C    | 1.27 (T.P.)                            |
| D    | 0.42 <sup>+0.08</sup> <sub>-0.07</sub> |
| E    | 0.1±0.1                                |
| F    | 1.57±0.2                               |
| G    | 1.49                                   |
| H    | 6.5±0.3                                |
| I    | 4.4±0.15                               |
| J    | 1.1±0.2                                |
| K    | 0.17 <sup>+0.08</sup> <sub>-0.07</sub> |
| L    | 0.6±0.2                                |
| M    | 0.12                                   |
| N    | 0.10                                   |
| P    | 3° <sup>+7°</sup> <sub>-3°</sub>       |

**NOTE ON CORRECT USE**

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to keep minimum ground impedance (to prevent undesired oscillation).  
All the ground pins must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) The inductor must be attached between Vcc and output pins. The inductance value should be determined in accordance with desired frequency.
- (5) The DC cut capacitor must be each attached to the input and output pins.

**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

| Soldering Method | Soldering Conditions   | Recommended Condition Symbol |
|------------------|--|------------------------------|
| Infrared Reflow  | Package peak temperature: 235 °C or below<br>Time: 30 seconds or less (at 210 °C)<br>Count: 3, Exposure limit <sup>Note</sup> : None | IR35-00-3                    |
| VPS              | Package peak temperature: 215 °C or below<br>Time: 40 seconds or less (at 200 °C)<br>Count: 3, Exposure limit <sup>Note</sup> : None | VP15-00-3                    |
| Wave Soldering   | Soldering bath temperature: 260 °C or below<br>Time: 10 seconds or less<br>Count: 1, Exposure limit <sup>Note</sup> : None           | WS60-00-1                    |
| Partial Heating  | Pin temperature: 300 °C<br>Time: 3 seconds or less (per side of device)<br>Exposure limit <sup>Note</sup> : None                     | -                            |

**Note** After opening the dry pack, keep it in a place below 25 °C and 65 % RH for the allowable storage period.

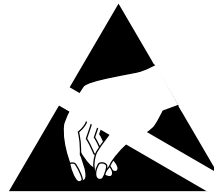
**Caution** Do not use different soldering methods together (except for partial heating).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).

[MEMO]

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## ATTENTION

OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
SENSITIVE  
DEVICES

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    - Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
    - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
    - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.
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